Attorney's Docket No. 5649-917

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

re: Chung et al. Serial No.: 10/043,027 Filed: January 9, 2002

TECHNOLOGY CENTER 28. Group Art Unit: 2813

Examiner: William C. Vesperman METHODS OF FORMING AN INTEGRATED CIRCUIT CAPACITOR IN WHICH

A METAL PREPROCESSED LAYER IS FORMED ON AN ELECTRODE

**THEREOF** 

Date: Februaary 3, 2004

Confirmation No.: 6119

Mail Stop Non-Fee Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

**AMENDMENT** 

Sir:

For:

Applicants provide the present Amendment to address the issues raised in the Official Action mailed November 6, 2003. Applicants provide the present Amendment pursuant to the rules stated in revised 37 C.F.R. 1.121 that became effective on July 30, 2003.